



MPD TPC ASSEMBLING (16.04.2025)

TPC:

vessel assembly, ROC chambers

Sub-systems:

- Gating grid system
- Electronics
- LV+HV system (CAEN)
- Gas system
- Cooling system
- Laser calibration system
- · Slow control

Integration of TPC to MPD

- Electronics platform
- Cabling and piping
- Installation TPC to MPD

Time schedule

Clean Room
(Detector Electronics)

Extracted beam

Collider

Collider

Collider

E-cooling

Internal torget

Heavy Ion Linac
Ion source

LU-20

Rooster

LU-20

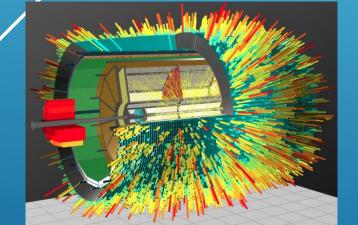
Rooster

LU-20

Augnet factory

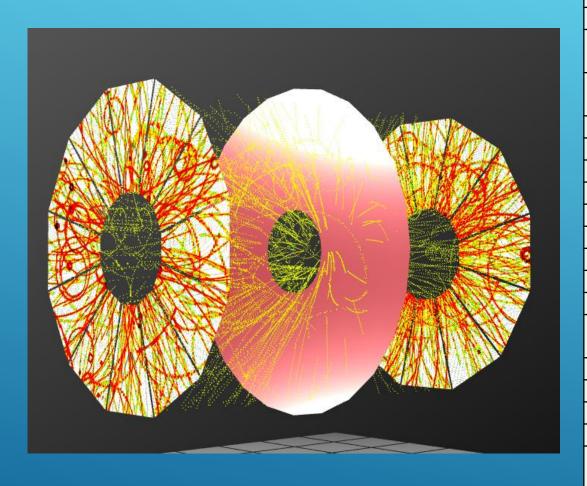
Augnet factory

Presented by S.Movchan



TPC team - 29 (JINR) + 20 (Belarus)

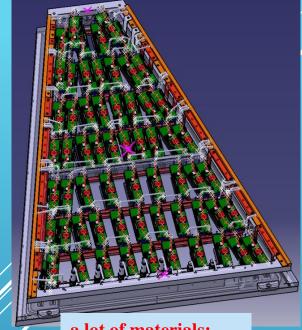
MPD TPC MAIN PARAMETERS



Item	Dimension
Length of the TPC	340cm
Outer radius of vessel	140cm
Inner radius of vessel	27 cm
Outer radius of the drift volume	133cm
Inner radius of the drift volume	34cm
Length of the drift volume	170cm (of each half)
HV electrode	Membrane at the center of the TPC
Electric field strength	~140V/cm;
Magnetic field strength	0.5 Tesla
Drift gas	90% Ar+10% Methane, Atmospheric pres. + 2 mbar
Gas amplification factor	~ 104
Drift velocity	5.45 cm/μs;
Drift time	< 30μs;
Temperature stability	< 0.5°C
Number of readout chambers	24 (12 per each end-plate)
Segmentation in φ	30°
Pad size	5x12mm ² and 5x18mm ²
Number of pads	95232
Pad raw numbers	53
Pad numbers after zero suppression	< 10%
Maximal event rate	< 7 kHz (Lum. 10 ²⁷)
Electronics shaping time	~180 ns (FWHM)
Signal-to-noise ratio	30:1
Signal dynamical range	10 bits
Sampling rate	10 MHz
Sampling depth	310 time buckets

MPD TPC RADIATION LENGTH (BASE LINE OPTION)

			istion length		1_	
	for n =	for η = 1.04 Θ = 38.87*		for η = 1.14 Θ = 35.55*	for η = 1.51	for η = 2.06
	Θ = 90°	$\Theta = 38.87^{\circ}$ $Cos(90^{\circ}-38.87^{\circ}) = 0.628$		$\Theta = 35.55^{\circ}$ $Cos(90^{\circ}-35.55^{\circ}) = 0.581$	O = 25.03° Cos(90°-25.03°) = 0.423	Θ = 14.51° Cos(90°-14.74°) = 0.251
C1 h=3 mm + Al foils	1.061	1.689		1.826	2.508	4.227
	0.020	0.032		0.034	0.047	0.080
N ₁ (gap C1-C2) h=65 mm C2 h=3 mm + Al strips on C2	0.020	1.525		1.649	2.265	3.817
	0.958					
TPC gas mixture L = 989 mm for η = 0 Potential degrader rods + field cage	0.771	1.228 (L=1574.8 mm) 0.135		1.125 (L=1443.8 mm)	0.830 (L=1164.8 mm)	0.252 (L=322.7 mm)
C3 h=4.05 mm + Al strips	1.275	2.030				
N ₂ (gap C3-C4) h=67 mm	0.020	0.032				
C4 h=6.4 mm	1.972	3.140				
TPC shielding Al, h=0.1 mm	0.112	0.178				
TPC thermal-screen (top) Al + H ₂ O, h=1.5mm	2.042	4.696				
Air (C4 up to TOF) h = 60 mm	0.020	0.032				
Sum [C1+N2(gap C1-C2) + C2 + gas mixture]:	= 9.24	= 14.71		4.63	5.65	8.38
			for Θ = 0*	for Θ ≈ 35.55°	for Θ ≈ 25.03°	for Θ ≈ 14.51°
				Cos(35.55°) = 0.814	Cos(25.03*) = 0.906	Cos(14.51°) = 0.168
ROC						
1. Wires			0.30	0.37	0.33	0.31
2. Pad plane h=3.4 mm + inside glue			2.83	3.48	3.12	2.92
3. Insulating plate h=3 mm			1.88	2.31	2.08	1.94
4. Al frame h=5 mm & ROC reinforce rib + ROC			6.54 + 0.91	8.03 + 1.12	7.22 + 1.00	6.75 ± 0.94
cooling tube (Cu) with water						`
5. Epoxy glue (2x0.1 mm)			0.056	0.069	0.062	0.058
6. Connectors + solder			0.34	0.42	0.38	0.35
Air gap L=100 mm			0.033	0.041	0.036	0.034
ROC MWPC sum:			12.89	15.84	14.28	13.30
FE (based on SAMPA chip)						
Components			0.33	0.41	0.36	0.34
FE = (2x12 layers)x2			2.32	2.85	2.56	2.40
Connectors + solder			0.34	0.42	0.38	0.35
FE sum:			2.99	3.68	3.30	3.09
FE Cooling						
Al plates on chips + Cu & Al pipes + water			7.10 ± 3.68	8.72 + 4.52	7.84 + 4.06	7.33 + 3.80
FE Cooling sum:			10.78	13.24	11.90	11.13
LV & DAQ+SC cables + signal cables + flat cables			~8.82 ± 0.19	~ 8.82 + 0.23	~ 8.82 + 0.21	~ 8.82 + 0.20
Service wheel (SSW) 12.5 kG (AI) + 0.25 kG bolts			NO			
Flange C1&C2 to C3&C4 (Al) 170 kg			NO			
TPC thermal-screen Al (flange)+Al (clamps) [m(Al)			~1.46	~1.79	~1.61	~1.51
= 21 kG] + H ₂ O			~0.01	~0.01	~0.01	~0.01
Summary:	= 9.24	= 14.71	37.14	~48.24	~ 45.73	~46.44



a lot of materials:

- ROC chamber
- Al chamber frame
- FE electronics
- cooling radiators
- cables
- pipes

END CAPS $(\eta = (1.14 \div 2.06))$: X/X0 = (47+/-1) %

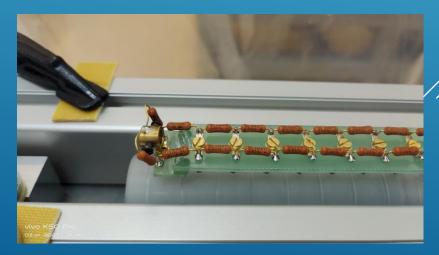
BARREL ($\eta = (0 \div 1.04)$): X/X0 = (12+/-2.7) %

TPC VESSEL ASSEMBLING: RODs D=40 MM WITH FIELD CAGE STRIPS

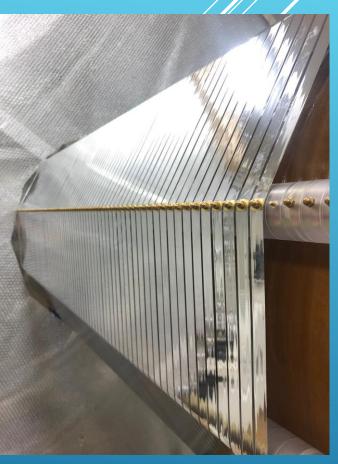




Rod with HV divider



Field cage HV strips



All 24 pc RODs D=40 mm are installed HV tested at -25 kV

Test setup for ROC certification



24 pc ROCs – tested



24 pc serial ROCs + 4 spare – READY!

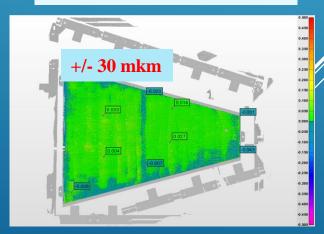
TPC ROC CHAMBERS

Test setup for pads calibration

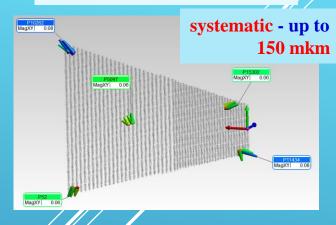


Leica MS60 - 1 second resolution Leica AT960 +/-10 mkm +5 mkm/m Leica AT403 +/-15 mkm +6 mkm/m Scanner AS1+AT960 +/-50 mkm

Pad plane unflatness: example



Check pads geometry



Full set of ROC alignment marks



Summary:

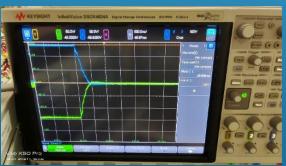
- measurements to do for all ROCs
- mapping of 3968 pads respect to ROC "reference hole" for each chamber
 - in progress

TPC SUB-SYSTEMS: GATING GRID SYSTEM (GGS)

ROC gating grid system: test setup

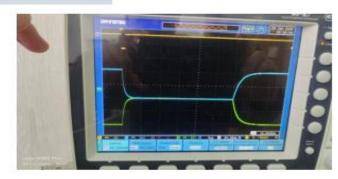






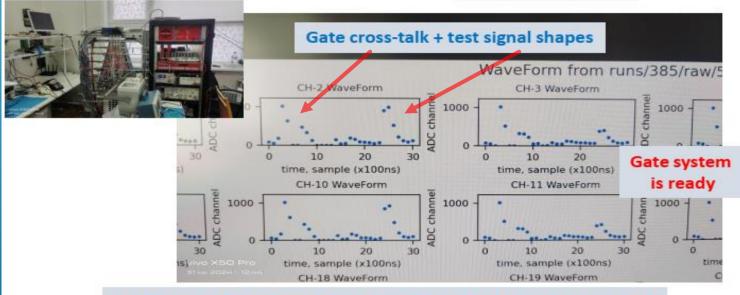
TPC Gating grid system





Test setup in Minsk

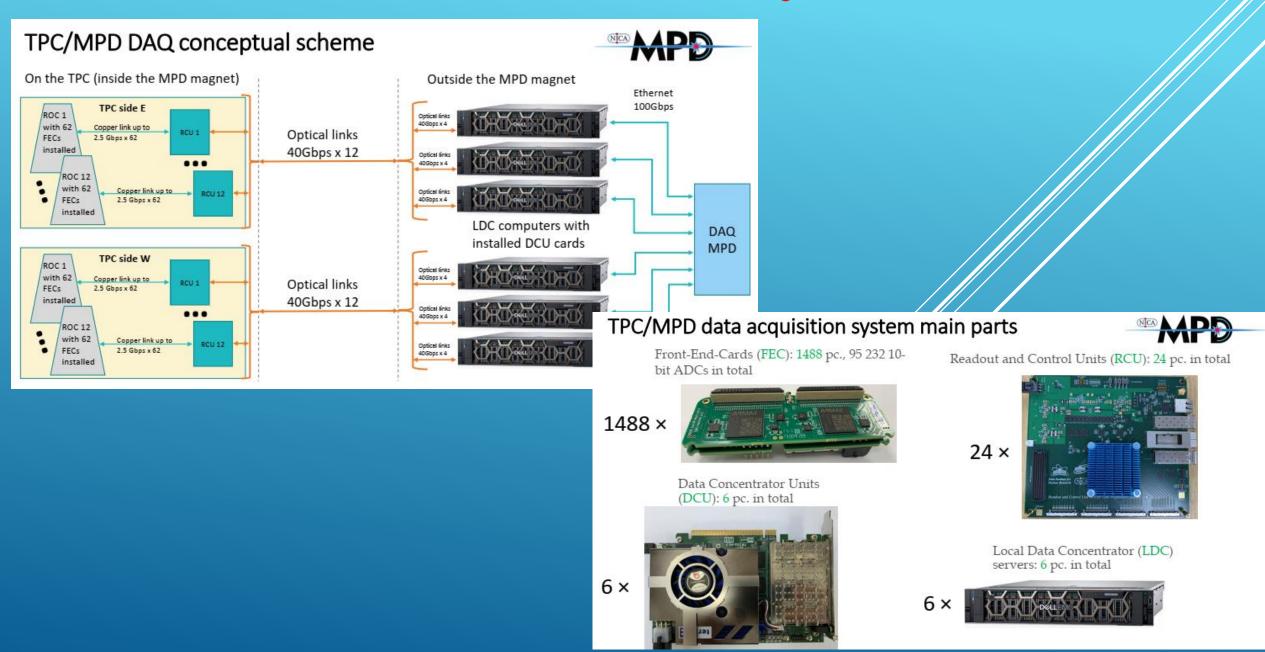
Rise time - 1 mksec Fall time - 2 mksec



Gate cross-talk is about 1,5 microsec + test signal (500 nanosec)

System long term test at Minsk – ongoing ... 3 modules (from 24) died and were repared SC software – in progress...

TPC SUB-SYSTEMS: DAQ



TPC SUB-SYSTEMS: ELECTRONICS

Readout and Control Unit (RCU)



RCU v.1.1

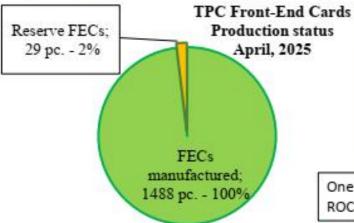
RCU v.1.2

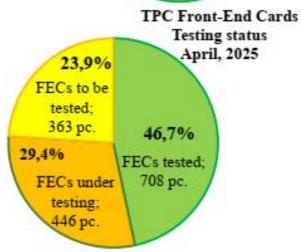
After RCU v.1.1 testing small corrections have been done and new one is under production now.



Front-End Cards (FEC)







FEE synchronization modules

Fanout 2x8 and translation to the optical signals. Will be installed on the MPD platform.



One ROC fanout module. Will be installed on the ROC (inside MPD magnet). On production now.

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GUI software for ROC FEE control and monitoring

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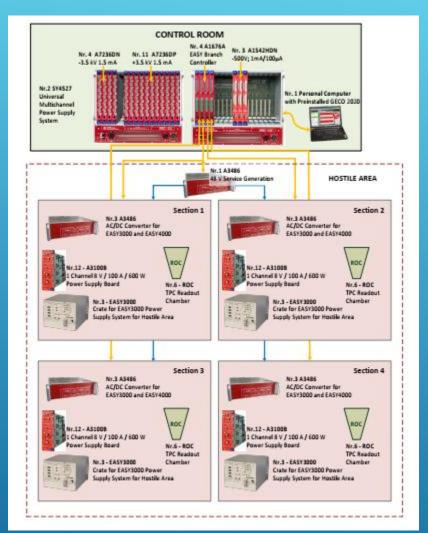
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HIII.

DIM

HILL



TPC SUB-SYSTEMS: LV+HV (CAEN)

LV&HV system based on CAEN rad. hard design:

(up to 2000 Gauss and 15 kRad)

- power converters A3486 AC/DC (380 V -> 48 V) -15+3 pc
- EASY3000 crates

- 14+2 pc

- LV module - A3100B (8V/100A)

- 48+8 pc
- LV module A3100HBP (14V/50A)
- 6 +2 pc
- HV modules –A3540P (+4kV/1mA)
- 8+3 pc
- HV modules -A3540N (- 4kV/1mA)
- 2+2 pc

+ CAEN LV modules 60pc -

delivered in September 2023

Status:

LV+HV system - delivered

LV cables (halogen free, low smoke, S=50 mm2)– delivered

HV cables – delivered



LV EM shielding

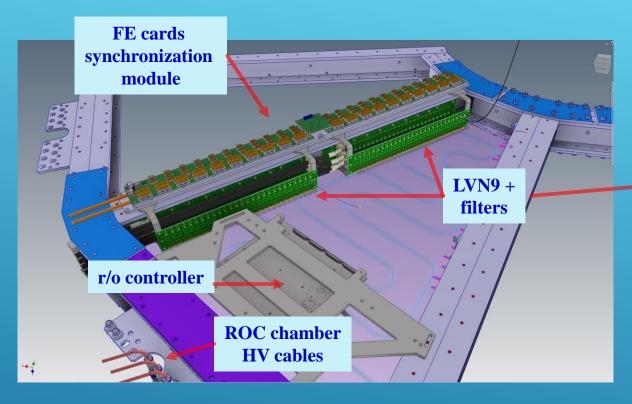


LV test setup - tests ongoing

Ready for installation to MPD: CAEN installation – a waiting Cabling:

Thermometry (~300) – May LV power (~120) – June-July

TPC SUB-SYSTEMS: LV INTEGRATION

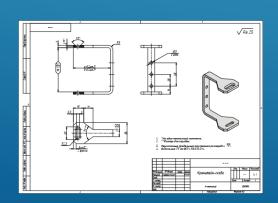


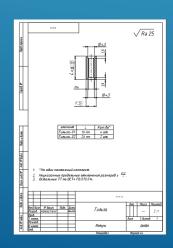












Gas system (Ar/CH4, 90:10)

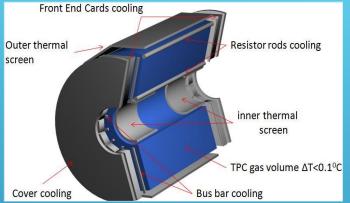


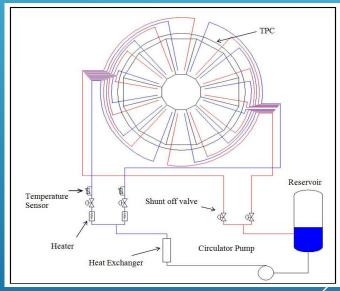


H20 and O2 sensors are replaced Tests - in progress

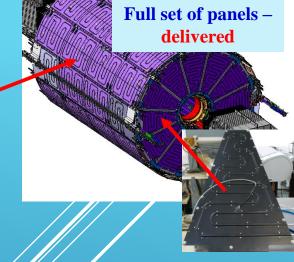
TPC SUB-SYSTEMS: GAS

Water cooling system











TPC SUB-SYSTEMS: COOLING







Connection to KOMETA cooling system -ready







Assembling and cabling – in progress...

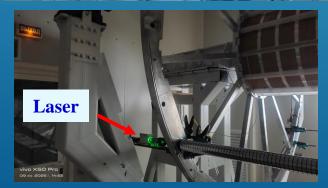
TPC SUB-SYSTEMS: LASER CALIBRATION SYSTEM

Test set up with UV laser



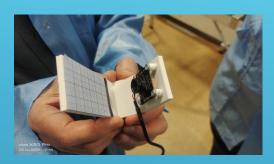
Test tube #7 with "green" laser

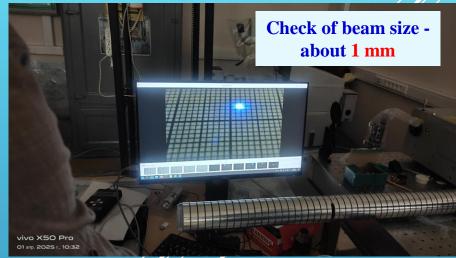


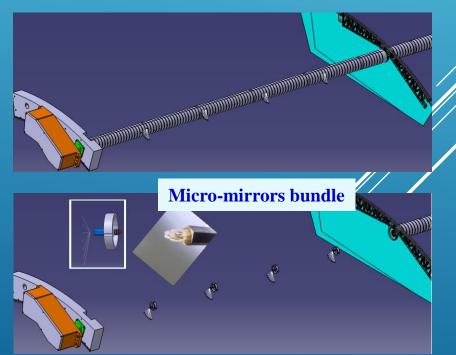






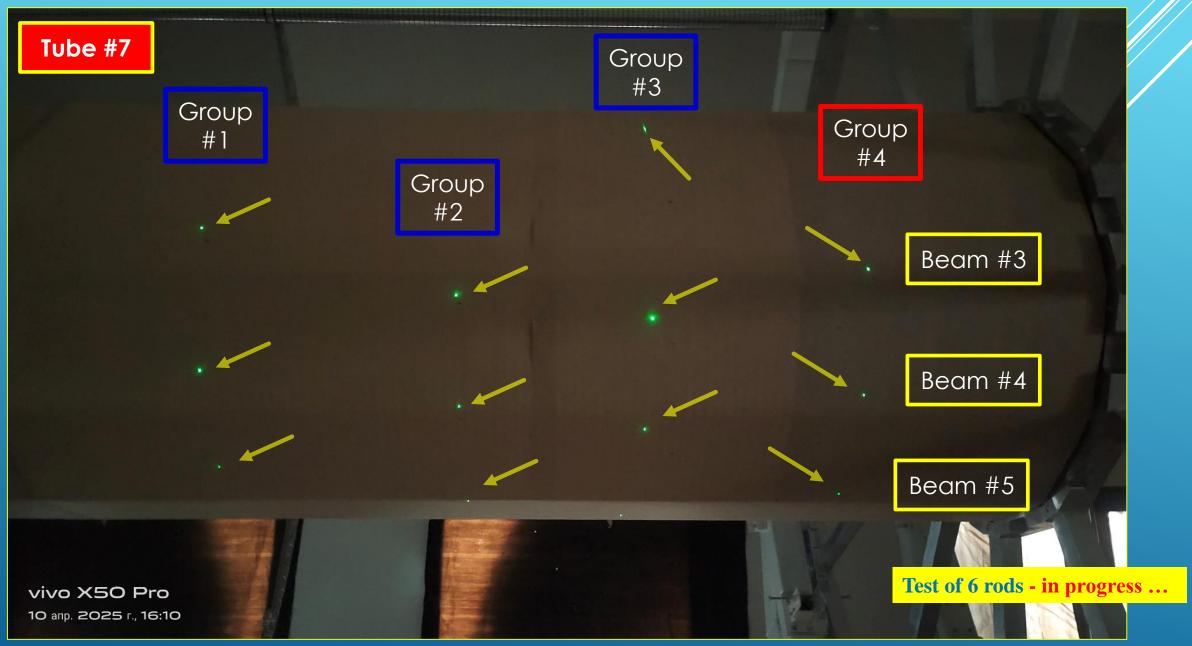








TPC SUB-SYSTEMS: LASER CALIBRATION SYSTEM

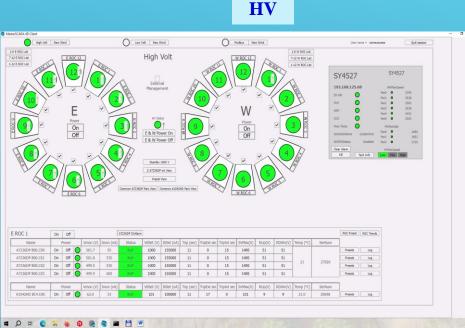


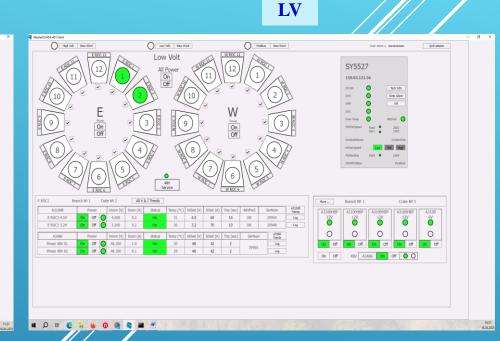
TPC SUB-SYSTEMS: SLOW CONTROL

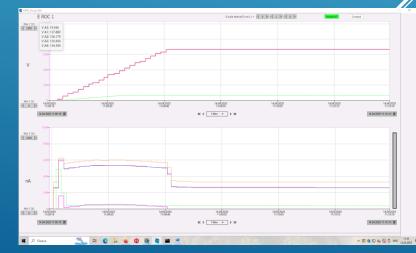
Main window of LV+HV GUI based on MasterScada 4D

CAEN LV test setup







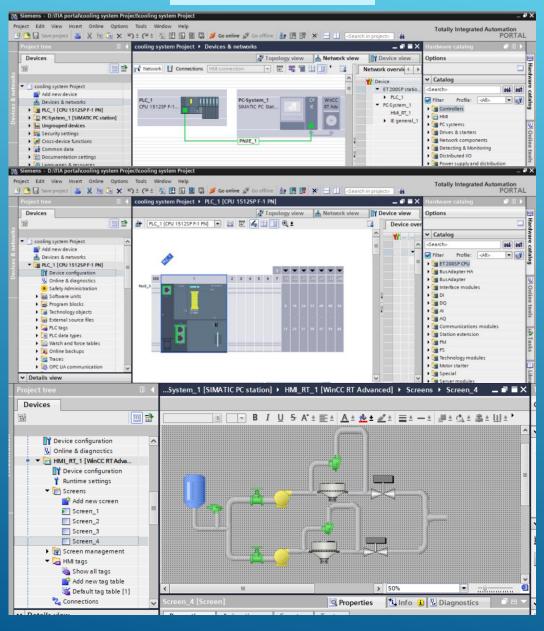


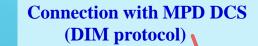
DATA transfer from MasterScada 4D to the DB POSTGRESQL16 – OK!

in progress ...

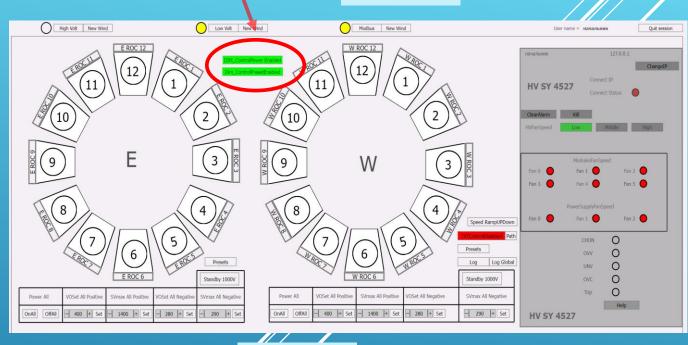
TPC SUB-SYSTEMS: SLOW CONTROL

GUI for cooling system





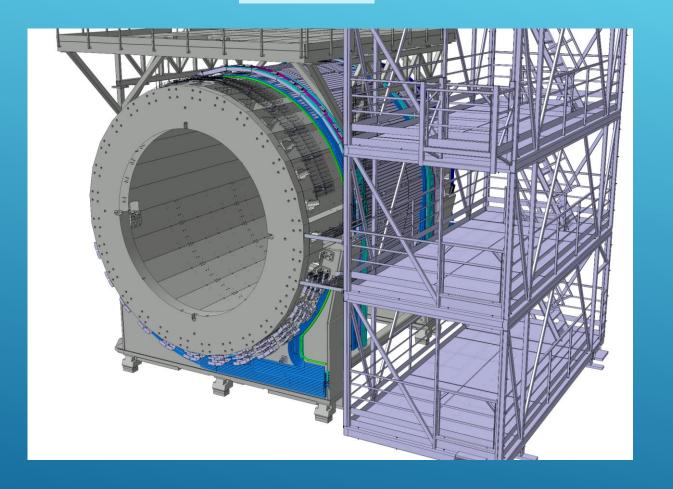
LV+HV

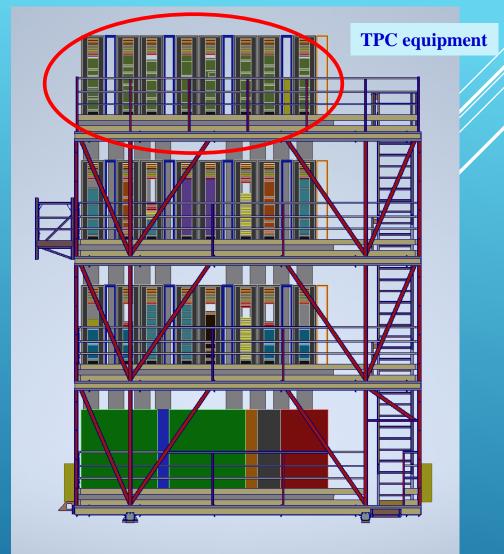




INTEGRATION: "ELECTRONICS" PLATFORM (NORTH)

Common view





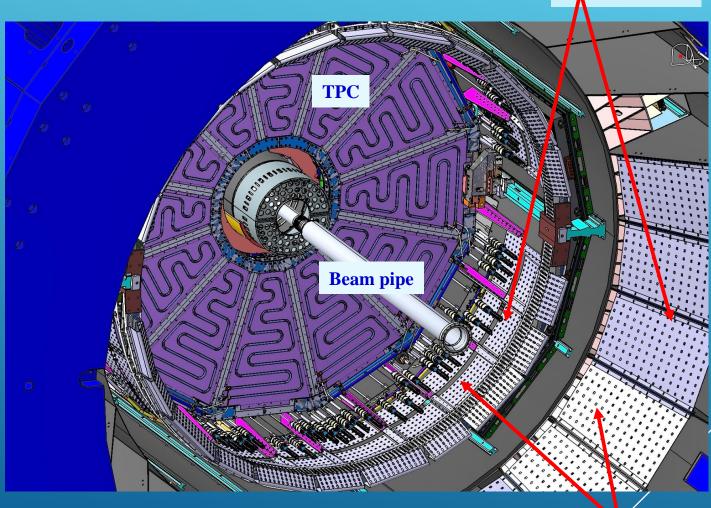
TPC CABLING AND PIPING

TPC piping (water)

Integration ...

Structures for cables and pipes

A fixation



Structure design - done

Full set of parts – in manufacture





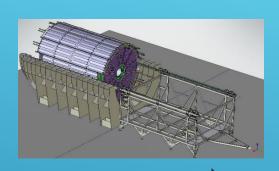


Piping and cabling - in progress ...

TOOLING FOR INSTALLATION OF TPC TO MPD

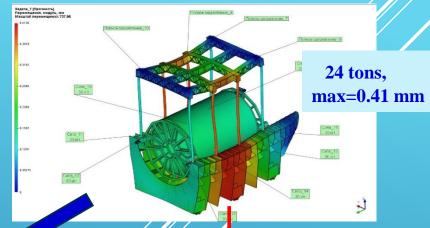
Bld. 217

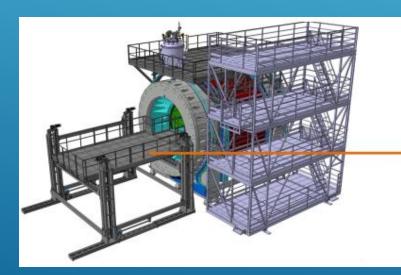




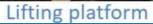
Bld. 17 (MPD)

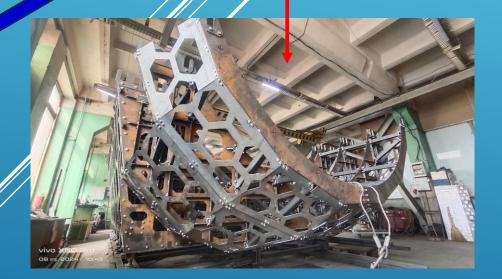












Tooling for installation TPC to MPD tested and delivered to JINR

STATUS AND TIME SCHEDULE

TPC sub-systems status:

TPC vessel assembling in progress

ROC chambers (24+6 spare) ready

FE electronics 100% manufactured (1488 FECs)

R/O controller v1.2 Test with ROC chamber – will be started soon Gating grid system ready, long term test at Minsk in progress

HV+LV systems (CAEN) ready for start installation to MPD TPC racks on Electronics platform

end of 2024

Gas system ready, waiting of gas piping at MPD building

Cooling system on TPC in progress (all radiators and thermal sheets ready, TPC collectors manufacture - contracted)

TPC+ECAL cooling system in progress (piping-done, cabling - in progress, assembling of automatics, software ...)

Laser system in progress (8 TPC rods with mirrors assembled, integration to MPD - started)

Slow control system in progress (LV +HV sub-systems based on OPS + MasterScada 4D ready, SC for rest TPC

sub-systems - started)

TPC schedule:

TPC:

TPC vessel assembled and tested June 15 2025

ROC chambers installation

July-August 2025

TPC tests (with laser tracks and cosmic ray)

Sept-Oct 2025

TPC tests (with laser tracks and cosmic ray)
TPC rails and installation tooling

Rails installation to ECAL support structure done (01/08/2024)

Tooling for installation TPC to MPD delivered

TPC+ECAL cooling systems (INP BSU, Minsk):

Delivery to JINR done (Sept 30 2024)

Systems assembling and start up — May 30 (3 water vessels and 3 pump modules are installed and tested (Dec 2024))

Commissioning June - Dec 2025

TPC installation to MPD Nov 01 - Nov 23 2025

Cabling June 22 – Nov 30 2025

MPD commissioning Dec 2025

RISKS

RISK:

TPC skeleton final geometry measurement (laser tracker or 3D scanner)

Laser system – measurement geometry of 1 mm beams inside TPC

Laser beam splitters - prisms and mirrors adjustment

TPC vessel - gas leak check and reparation

TPC + ROCs - gas leak check and reparation

FE electronics installation and tests (noise and generation)

TPC tests

Move TPC to MPD hall

Test TPC at MPD hall

Installation TPC to MPD

TPC adjustment (magnetic lines and TPC E field axis align)

Alignment TPC inside MPD

Cabling and piping

TPC tests

TPC laser system: external mirrors adjustment

BELARUS CONTRIBUTION TO TPC

Mechanics («ARTMASH» and "KRAINA" Minsk):

- MPD mockup 1:5
- TPC flanges (2 pc) + HV electrode (1 pc)
- service wheel (2pc)
- FE cooling radiators (30 sets)
- LVN9 cooling radiators (9 pc)
- tooling for installation TPC to MP: mockup 1:5 and serial
- TPC serial rails 6 meters (2 pc)

Electronics (INP BSU):

- LVN9 stabilization module (48 pc)
- burning test setup for tests of FE electronics (1 pc)
- setup for test FE cards (1 pc)
- test of FE cards (600 pc) in progress
- system for anode signal measurements (96ch) in progress
- gate system for ROC chamber (24ch)

TPC + **ECAL** cooling system (INP BSU - full responsibility)

- cooling setup for tests (2 pc)
- 3 serial systems in progress

R&D (**INP BSU**,):

- ThGEM: tests and study
- DLC like protection coating from sparks for gas detectors
- DLC study: structures and long term stability
- metalize nuclear membrane like mesh for electrons and ions drift

MPD and SPD detectors grounding (Институт Энергетики БАН)

БГУ, НИИ ЯП БГУ, НИИ Физ.-хим. проблем БГУ, ООО «Вист групп сенсор», УП «АРТМАШ», «НП КРАИНА», Институт энергетики ...

Many Thanks!!!!

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Fedotov A.

Fedotova Yu.A.

Galkin Ya.

Haluza A.

Kunts A.

Lushachkin D.

Litomin A.

Losev A.

Savitskiy S.N.

Savitskiy S.S.

Senkevich V.

Shmanai E.

Tchekhovskiy V.

Yuhno Yu.M

Vaschilenko M.

Zur I.

• • •

sorry if anybody forgotten

